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## BSS138-F085

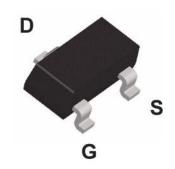
## N-Channel Logic Level Enhancement Mode Field Effect Transistor

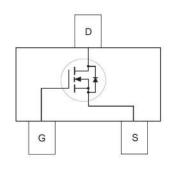
#### **General Description**

These N-Channel enhancement mode field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. These products have been designed to minimize on-state resistance while provide rugged, reliable, and fast switching performance. These products are particularly suited for low voltage, low current applications such as small servo motor control, power MOSFET gate drivers, and other switching applications.

#### **Features**

- · Automotive Qualified
- 0.22 A, 50 V. RDS(ON) =  $3.5\Omega$  @ VGS = 10 V  $RDS(ON) = 6.0\Omega$  @ VGS = 4.5 V
- High density cell design for extremely low RDS(ON)
- · Rugged and Reliable
- · Compact industry standard SOT-23 surface mount package





#### **Absolute Maximum Rations**

**SOT-23** 

T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter	Units	Symbol
V <sub>DSS</sub>	Drain-Source Voltage	50	V
$V_{GSS}$	Gate-Source Voltage	±20	V
	Drain Current – Continuous (Note 1)	0.22	Α
ID	- Pulsed	0.88	^
В	Maximum Power Dissipation (Note 1)	0.36	W
$P_{D}$	Derate Above 25°C	2.8	mW/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range	-55 to +150	°C
TL	Maximum Lead Temperature for Soldering Purposes, 1/16" from Case for 10 Seconds	300	°C

#### **Thermal Characteristics**

$R_{\theta JA}$ Thermal Resistance, Junction-to-Ambient	(Note 1)	350	°C/W
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#### **Package Marking and Ordering Information**

Device Marking	Device	Device Reel Size Tape width		Quantity
SS	BSS138-F085	7"	8mm	3000 units

#### **Electrical Characteristics**

**Symbol** 

**Parameter** 

T<sub>A</sub> = 25°C unless otherwise noted

**Test Conditions** 

Min

Тур

Max

Unit

Off Ch	aracteristics					
BV <sub>DSS</sub>	Drain–Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \qquad I_D = 250  \mu\text{A}$	50			V
ΔBVDSS / ΔTJ	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250 μA, Referenced to 25°C		72		mV/°C
		V <sub>DS</sub> = 50V, V <sub>GS</sub> = 0 V			0.5	μΑ
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 50V$ , $V_{GS} = 0 V$ , $T_{J} = 125^{\circ}C$			5	μΑ
		$V_{DS} = 30V$ , $V_{GS} = 0 V$			100	nA
I <sub>GSS</sub>	Gate-Body Leakage	$V_{GS} = \pm 20V$ , $V_{DS} = 0 V$			±100	nA

#### On Characteristics (Note2)

V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}$	I <sub>D</sub> = 1 mA	8.0	1.3	1.5	V
$\Delta V_{GS(th)}$ / $\Delta T_J$	Gate Threshold Voltage Temperature Coefficient	I <sub>D</sub> = 1 mA, Refe	renced to 25°C		-2		mV/°C
		V <sub>GS</sub> = 10 V,	I <sub>D</sub> = 0.22 A		0.7	3.5	
R <sub>DS(on)</sub>	Static Drain–Source On–Resistance	V <sub>GS</sub> = 4.5 V,	I <sub>D</sub> = 0.22 A		1.0	6.0	Ω
		V <sub>GS</sub> = 10 V, I <sub>D</sub> =	: 0.22 A, T <sub>J</sub> = 125°C		1.1	5.8	•
I <sub>D(on)</sub>	On-State Drain Current	V <sub>GS</sub> = 10 V,	V <sub>DS</sub> = 5 V	0.2			Α
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 10 V,	I <sub>D</sub> = 0.22 A	0.12	0.5		S

### **Dynamic Characteristics**

-					
C <sub>iss</sub>	Input Capacitance	.,		27	pF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 25 V, f = 1.0 MHz	$V_{GS} = 0 V$ ,	13	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			6	pF
R <sub>G</sub>	Gate Resistance	V <sub>GS</sub> = 15 mV,	f = 1.0 MHz	9	Ω

### Switching Characteristics (Note2)

t <sub>d(on)</sub>	Turn-On Delay Time		= 30 V, I <sub>D</sub> = 0.29 A,	2.8	5.8	ns
t <sub>r</sub>	Turn-On Rise Time	V <sub>DD</sub> = 30 V,		2.1	4.4	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>GS</sub> = 10 V,	$R_{GEN} = 6 \Omega$	9.6	19.2	ns
t <sub>f</sub>	Turn-Off Fall Time			8.4	16.8	ns
Qg	Total Gate Charge			1.7	2.4	nC
$Q_{gs}$	Gate-Source Charge	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 10 V	$I_D = 0.22 A,$	0.1		nC
$Q_{gd}$	Gate-Drain Charge	VGS 10 V		0.4		nC

# **Drain-Source Diode Characteristics and Maximum Ratings**

Is	Maximum Continuous Drain-Source Diode Forward Current					0.22	Α
VsD	Drain–Source Diode Forward Voltage	V <sub>GS</sub> = 0 V,	I <sub>S</sub> = 0.44 A	(Note 2)	0.8	1.4	V

#### Notes

1.  $R_{\text{NJA}}$  is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\text{NJC}}$  is guaranteed by design while  $R_{\text{NJA}}$  is determined by the user's board design.



a) 350°C/W when mounted on a minimum pad.

Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

### **Typical Performance Characteristics**

Figure 1. On-Region Characteristics

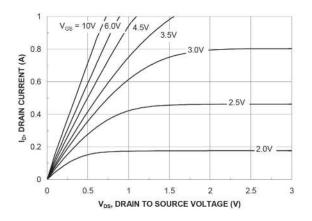


Figure 3. On-Resistance Variation with Temperature

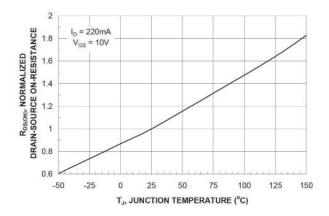


Figure 5. Transfer Characteristics

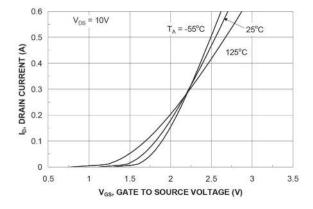


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage

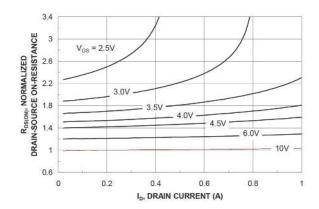


Figure 4. On-Resistance Variation with Gate-to-Source Voltage

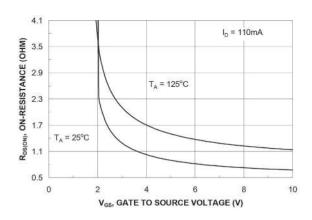
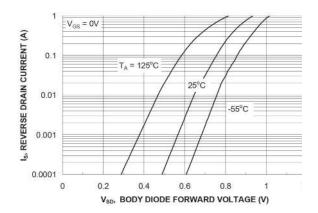


Figure 5. Body Diode Forward Voltage Variation with Source Current and Temperature



#### **Typical Performance Characteristics**

Figure 7. Gate Charge Characteristics

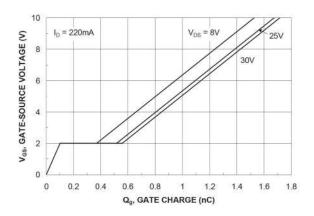


Figure 8. Capacitance Characteristics

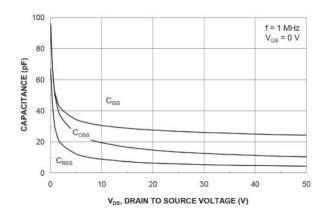


Figure 9. Maximum Safe Operating Area

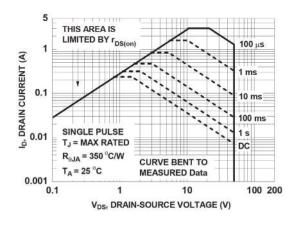


Figure 10. Single Pulse Maximum Power Dissipation

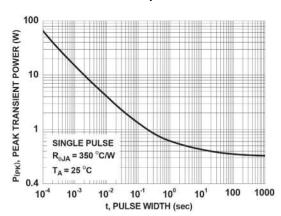
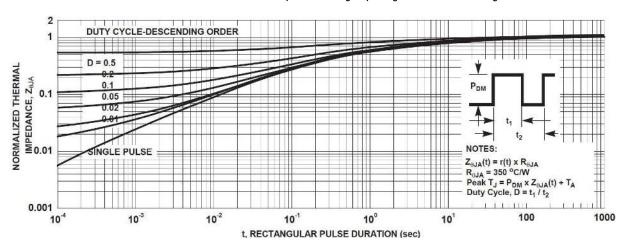


Figure 11. Transient Thermal Response Curve

Thermal characterization performed using the conditions described in Note 1a Transient thermal response will change depending on the circuit board design



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